onsemi

$\frac{\text{MOSFET}}{\text{N-Channel SuperFET}^{\mathbb{R}}} - \text{Power, Single} \\ \text{N-Channel SuperFET}^{\mathbb{R}} \text{V,} \\ \text{FRFET}^{\mathbb{R}}, \text{D}^{2}\text{PAK} \\ \text{600 V, 55 m}\Omega, 45 \text{ A} \\ \text{NVB055N60S5F} \\ \end{array}$

Description

The SUPERFET V MOSFET FRFET series has optimized body diode performance characteristics. This can allow for the removal of components in the application and improve application performance and reliability, particularly when soft switching topologies are used.

Features

- $650 \text{ V} @ \text{T}_{\text{J}} = 150^{\circ}\text{C} / \text{Typ. } \text{R}_{\text{DS(on)}} = 44 \text{ m}\Omega$
- 100% Avalanche Tested
- Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- Electric Vehicle On Board Chargers
- EV Main Battery DC/DC Converters

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

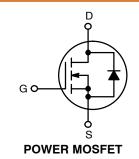
Parameter	Symbol	Value	Unit	
Drain-to-Source Voltage		V _{DSS}	600	V
Gate-to-Source Voltage	DC	V _{GS}	±30	V
	AC (f > 1 Hz)		±30	
Continuous Drain Current	T _C = 25°C	۱ _D	45	А
	T _C = 100°C		28	
Power Dissipation	T _C = 25°C	PD	278	W
Pulsed Drain Current	т огоо	I _{DM}	159	А
Pulsed Source Current (Body Diode)	T _C = 25°C, t _P = 10 μs	I _{SM}	159	
Operating Junction and Storage Range	Temperature	T _J , T _{stg}	–55 to +150	°C
Source Current (Body Diode)		I _S	45	А
Single Pulse Avalanche Energy	$(I_L = 7 \text{ A}, R_G = 25 \Omega)$	E _{AS}	417	mJ
Avalanche Current		I _{AS}	7	А
Repetitive Avalanche Energy (Note 1)		E _{AR}	2.78	mJ
MOSFET dv/dt		dvdt	120	V/ns
Peak Diode Recovery dv/dt (No	te 2)	70		
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		ΤL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive rating: pulse-width limited by maximum junction temperature.

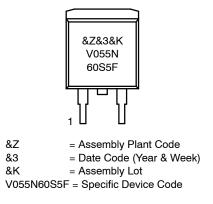
2. $I_{SD} \le$ 22.5 A, di/dt \le 200 A/µs, V_{DD} \le 400 V, starting T_J = 25°C.

V _{DSS}	R _{DS(ON)} MAX	I _D MAX
600 V	55 mΩ @ 10 V	45 A





MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

THERMAL RESISTANCE

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case, Max.	$R_{\theta JC}$	0.45	°C/W
Thermal Resistance, Junction-to-Ambient, Max.	$R_{\theta JA}$	62.5	

ELECTRICAL CHARACTERISTICS (T_{.1} = 25°C unless otherwise noted)

Parameter	Symbol Test Conditions			Тур	Max	Unit	
OFF CHARACTERISTICS						-	
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_D = 1 mA, T_J = 25 $^\circ C$	600	-	-	V	
Drain-to-Source Breakdown Voltage Temperature Coefficient	$\Delta V_{(BR)DSS}/ \Delta T_J$	I_D = 10 mA, Referenced to 25°C	_	581	-	mV/°C	
Zero Gate Voltage Drain Current	I _{DSS}	V_{GS} = 0 V, V_{DS} = 600 V, T_{J} = 25 $^{\circ}C$	_	-	10	μΑ	
Gate-to-Source Leakage Current	I _{GSS}	$V_{GS}=\pm30~V,~V_{DS}=0~V$	_	-	±100	nA	
ON CHARACTERISTICS							
Drain-to-Source On Resistance	R _{DS(on)}	V_{GS} = 10 V, I_D = 22.5 A, T_J = 25 $^\circ C$	_	44	55	mΩ	
Gate Threshold Voltage	V _{GS(th)}	V_{GS} = V_{DS} , I_D = 5.2 mA, T_J = 25°C	3.2	-	4.8	V	
Forward Trans-conductance	9fs	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 22.5 \text{ A}$	Ι	44.8	-	S	
CHARGES, CAPACITANCES & GATE	RESISTANCE						
Input Capacitance	C _{ISS}	V_{DS} = 400 V, V_{GS} = 0 V, f = 250 kHz	-	4603	-	pF	
Output Capacitance	C _{OSS}		-	72.9	-		
Time Related Output Capacitance	C _{OSS(tr.)}	$I_{D} = Constant, V_{DS} = 0 V to 400 V, \\ V_{GS} = 0 V$	_	1114	-	-	
Energy Related Output Capacitance	C _{OSS(er.)}	$V_{DS} = 0 V \text{ to } 400 V, V_{GS} = 0 V$		125	-		
Total Gate Charge	Q _{G(tot)}	V_{DD} = 400 V, I _D = 22.5 A, V _{GS} = 10 V	-	85.2	-	nC	
Gate-to-Source Charge	Q _{GS}		-	26.2	-		
Gate-to-Drain Charge	Q _{GD}		-	24.9	-		
Gate Resistance	R _G	f = 1 MHz	-	4.32	-	Ω	
SWITCHING CHARACTERISTICS							
Turn-On Delay Time	t _{d(on)}	$V_{GS} = 0/10 \text{ V}, V_{DD} = 400 \text{ V},$	-	44	-	ns	
Rise Time	t _r	$I_{\rm D} = 22.5 \text{ A}, \text{ R}_{\rm G} = 4.7 \Omega$	_	26.2	-		
Turn-Off Delay Time	t _{d(off)}	1	-	108	-		
Fall Time	t _f	1	-	2.6	-		
SOURCE-TO-DRAIN DIODE CHARAC	TERISTICS	•		-	-	-	
Forward Diode Voltage	V _{SD}	V_{GS} = 0 V, I _{SD} = 22.5 A, T _J = 25°C	-	-	1.2	V	
Reverse Recovery Time	t _{RR}	$V_{GS} = 0 \text{ V}, \text{ I}_{SD} = 22.5 \text{ A},$	-	128	-	ns	
Reverse Recovery Charge	Q _{BB}	dl/dt = 100 A/µs, V _{DD} = 400 V	_	758	_	nC	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

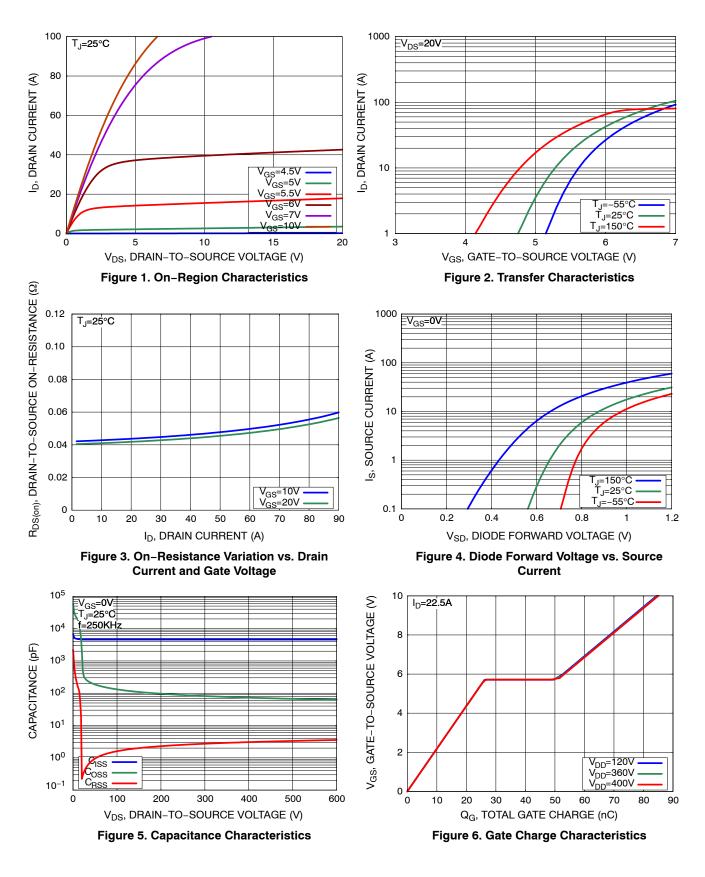
PACKAGE MARKING AND ORDERING INFORMATION

Q_{RR}

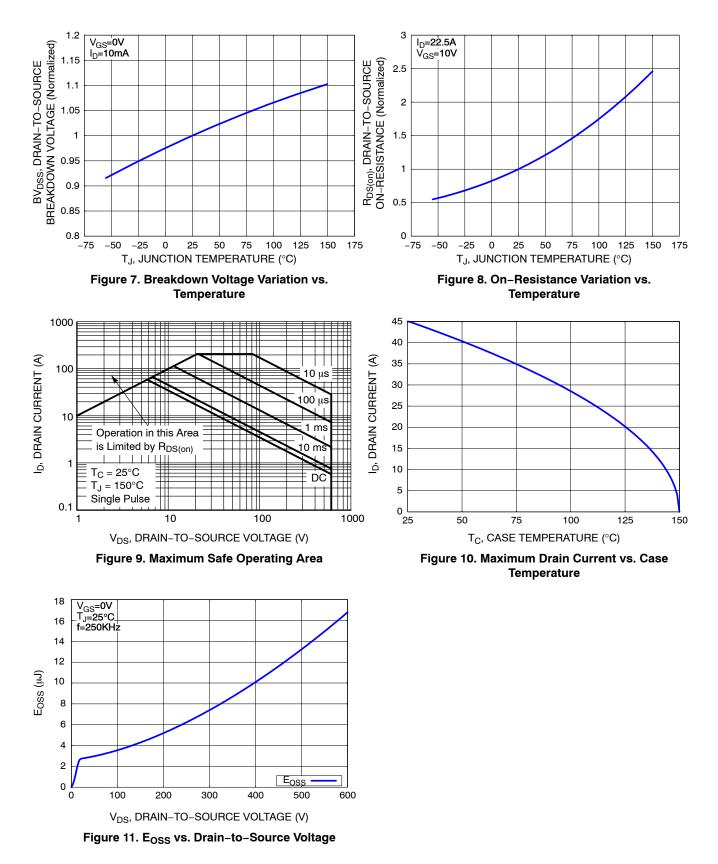
Part Number	Top Marking	Package	Packing Method	Reel Size	Tape Width	Quantity
NVB055N60S5F	V055N60S5F	D ² PAK	Tape & Reel [†]	330 mm	24 mm	800 Units

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

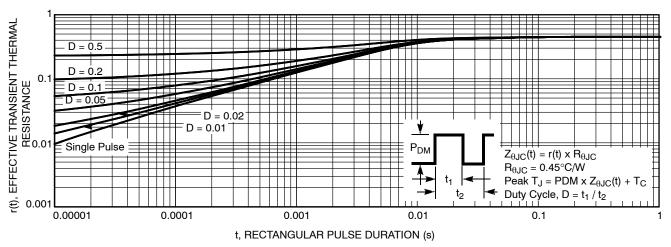


Figure 12. Transient Thermal Impedance

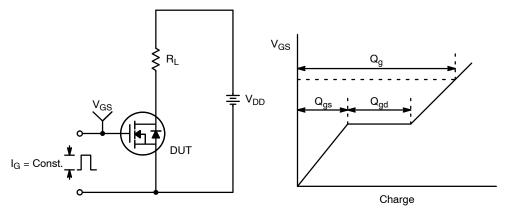


Figure 13. Gate Charge Test Circuit & Waveform

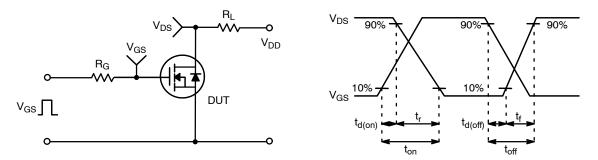


Figure 14. Resistive Switching Test Circuit & Waveforms

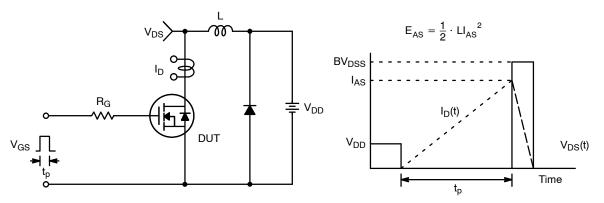


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

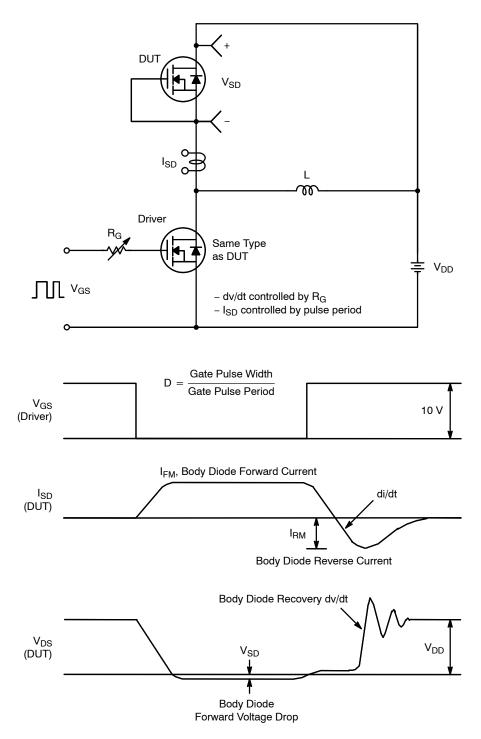
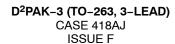


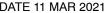
Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

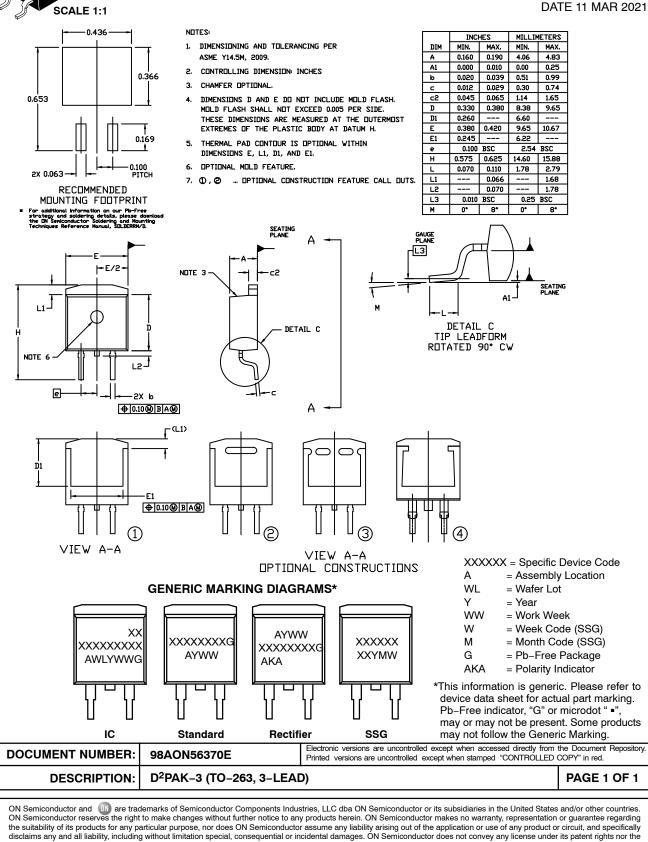
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MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS









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